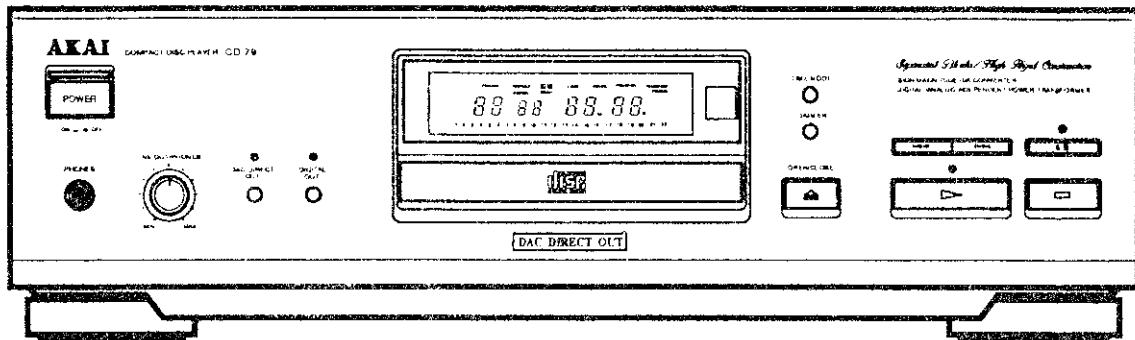


AKAI SERVICE MANUAL



MODEL CD-79

COMPACT
disc
DIGITAL AUDIO

COMPACT DISC PLAYER

MODEL CD-69
MODEL CD-79

SPECIFICATIONS

Pick-up	3 beam Laser pick up	Output level/Impedance
Pick-up system	Linear tracking	Analog (Fixed) 2.0 V/47 ohms
Sampling frequency	44.1 kHz	Analog (Variable) 2.0 V/47 ohms
Digital filter	20 bit, 8 times over sampling	Digital (Coaxial) 0.5 Vp-p/75 ohms
D/A converter	Sign magnitude L, R independent	Digital (Optical)..... -22 dBs, wave length 660 nm
Error correction system ..	Cross Interleave Reed Solomon	Headphone 25 mW/32 ohms
Number of channels	2 channels stereo	Power requirements :.... 220 V-230 V, 50 Hz for Europe except UK 240 V, 50 Hz for JK
Frequency response	2 Hz to 20 kHz ± 0.5 dB	Dimensions 425 (W) x 120 (H) x 348 (D) mm
Dynamic range		Weight
CD-69	100 dB	CD-69 5.7 kg
CD-79	101 dB	CD-79 9.3 kg
S/N		Standard accessories
CD-69	114 dB	Connection cord 1
CD-79	116 dB	Remote control unit 1
Total harmonic distortion		Batteries for remote control unit..... 2
CD-69	0.0022 % or less	Operator's manual 1
CD-79	0.0018 % or less	
Wow & flutter	Less than measurable limits	

* For improvement purposes, specifications and design are subject to change without notice.

★ SAFETY INSTRUCTIONS

PRECAUTIONS DURING SERVICING

- Parts identified by the symbol are critical for safety. Replace them only with the parts number specified.
- In addition to safety, other parts and assemblies are specified for conformance with such regulations as those applying to spurious radiation. These must also be replaced only with the specified replacements. Examples: RF converters, tuner units, antenna selector switches, RF cables, noise blocking capacitors, noise blocking filters, etc.
- Use specified internal wiring. Note especially:
 - Wires covered with PVC tubing
 - Double insulated wires
 - High voltage leads
- Use specified insulating materials for hazardous live parts. Note especially:
 - Insulation Tape
 - PVC tubing
 - Spacers (insulating barriers)
 - Insulation sheets for transistors
 - Plastic screws for fixing microswitch (especially in turntable)
- When replacing AC primary side components (transformers, power cords, noise blocking capacitors, etc.), wrap the ends of the wires securely about the terminals before soldering.



- Make sure that wires do not contact heat producing parts (heat sinks, oxide metal film resistors, fusible resistors, etc.).
- Check that replaced wires do not contact sharp edged or pointed parts.
- Also check areas surrounding repaired locations.
- Make sure that foreign objects (screws, solder droplets, etc.) do not remain inside the set.

SAFETY CHECK AFTER SERVICING

After servicing, make measurements of leakage-current or resistance in order to determine that exposed parts are acceptably insulated from the supply circuit. The leakage-current measurement should be done between accessible metal parts (such as chassis, ground terminal, microphone jacks, signal input / output connectors, etc.) and the earth ground through a resistor of 1500 ohms paralleled with a 0.15 μF capacitor, under the unit's normal working conditions. The leakage-current should be less than 0.5 mA rms AC. The resistance measurement should be done between accessible exposed metal parts and power cord plug prongs with the power switch (if included) "ON". The resistance should be more than 2.2 Mohms.

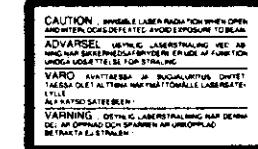
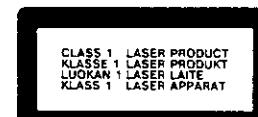
MAKE YOUR CONTRIBUTION TO PROTECT THE ENVIRONMENT

Used batteries with the ISO symbol for recycling as well as small accumulators (rechargeable batteries), mini-batteries (cells) and starter batteries should not be thrown into the garbage can. Please leave them at an appropriate depot. All other household batteries can be thrown out with the household waste.



CLASS 1 LASER PRODUCT

This product contains a low power laser device. To ensure continued safety, do not remove any covers or attempt to gain access to the inside of the product. Refer any servicing to qualified personnel. Use actual size stickers

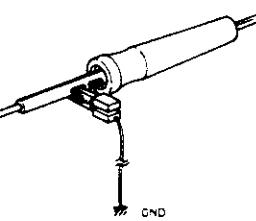


★ INFORMATION

SYMBOLS FOR PRIMARY DESTINATION

Primary destination of units are indicated with the following alphabet.

Symbols	Principal Destinations
	UK
	Europe (except UK)
	Australia
	Germany
	Universal Area
	Custom version



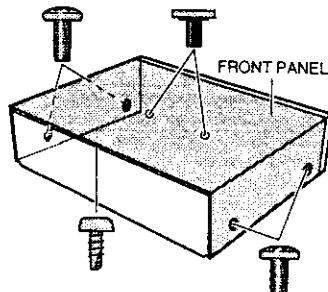
- Do not put excessive pressure on the mechanical part (operation part), including the pick-up block, as extremely high mechanical precision is required in these parts.
- When the base is removed for repair or adjustment, make sure that there are no metal objects in the narrow gap between the P.C.board or the mecha parts and the base.
- The Micro-Computer and the CD signal processing ICs can be damaged by static electricity or leakage from a soldering iron during repairing. While soldering, please take the precautions against leakage as in the illustration.
- Do not loosen any screws in the pick-up block. When handing the pick-up block, please refer to the points to NOTE when replacing the pick-up block.
- Keep safety for hazardous invisible Laser Radiation, DO NOT watch the Laser Beam (Objective lens) directly.
- Models for some countries, laser warning labels are affixed on the unit and inside of the unit, as shown below. Read it carefully for your safety, when repairing or adjusting the unit.

I. DISASSEMBLY

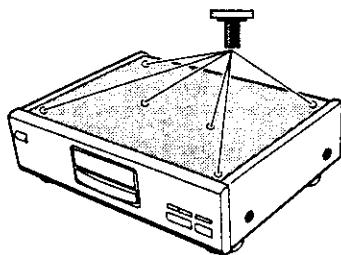
In case of trouble, etc, necessitating dismantling, please dismantle in the order shown in the illustrations.
Reassemble in the reverse order.

1. Removal of the UPPER COVER

For model CD-69

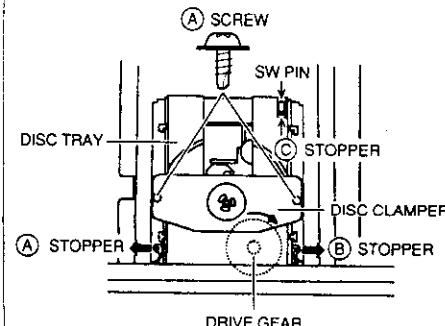


For model CD-79

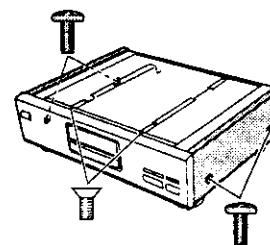


2. Removal of the DISC TRAY

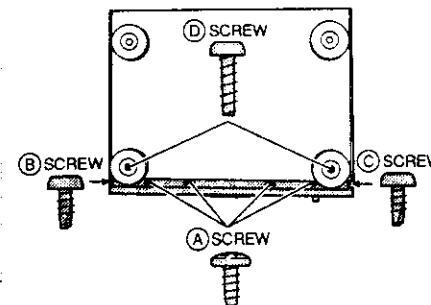
- Remove the two **A** screws on the DISC CLAMPER.
- Release the **C** stopper, then remove the SW PIN.
(This part is not available as a service part. Remove it from the old tray and replace it in the new one when changing the tray.)
- Turn the DRIVE GEAR in the direction of the arrow until the tray reaches fully open position.
- While pulling both the **A** and **B** stoppers in the direction of the arrows individually, remove the DISC TRAY by pulling it forward.



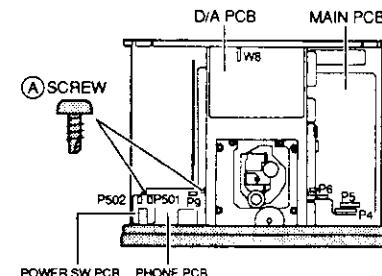
3. Removal of the FRONT PANEL BLOCK



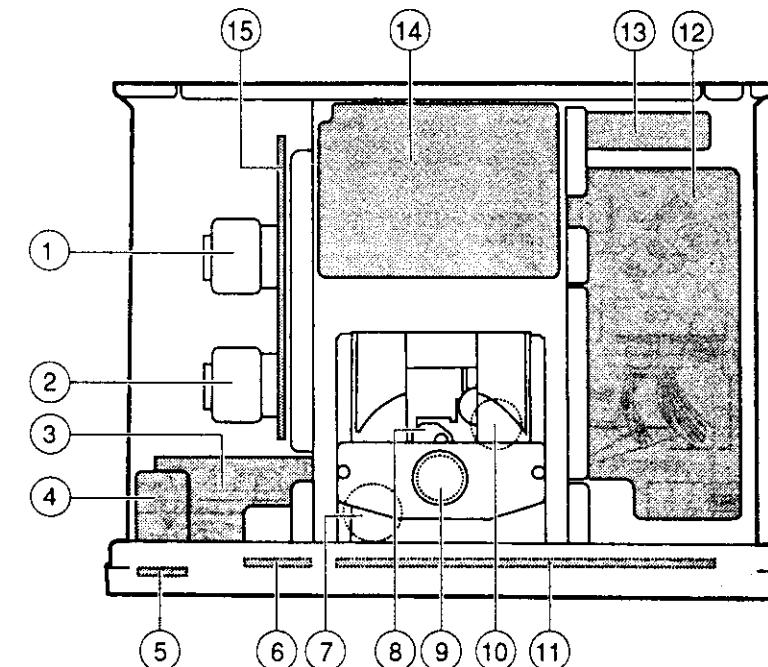
- Remove the four **A** screws and loosen the **B** screws on the bottom.
- Remove the **B**, **C** screws on the both side.



- Remove the two **A** screws on the PHONE PCB.
- Disconnect the connector P4, P5 and P6 on the MAIN PCB, and W8 on the D/A PCB.
- Disconnect the connector P9 on the PHONE PCB and P501, P502 on the POWER SW PCB.



II. PRINCIPAL PARTS LOCATION



- POWER TRANSFORMER (CD-79 only)
- POWER TRANSFORMER
- PHONE PCB
- POWER SW PCB
- LED PCB
- DAC SW PCB
- LOADING MOTOR
- PICK UP BLOCK

- SPINDLE MOTOR
- SLED MOTOR
- OPERATION PCB
- MAIN PCB
- DIGITAL OUT PCB
- D/A PCB
- POWER SUPPLY PCB

III. REPLACEMENT OF THE PRINCIPAL COMPONENTS

3-1. PRECAUTION, WHEN REPLACING THE PICK UP BLOCK

When connecting or disconnecting the connectors P101 and P102, make sure that the P.C. Board (on the PICK-UP Block) has to be shorted circuit as shown in Fig. 3-1. Do not turn the electricity "ON" while it remain shorted circuit.

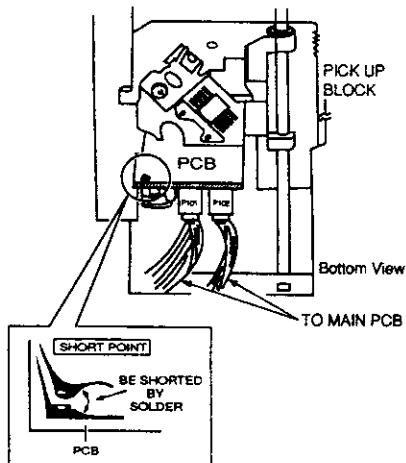


Fig. 3-1

3-2. REMOVAL OF THE MECHANISM BLOCK

- 1) Remove the DISC TRAY and DISC CLAMPER. (Refer to 1-2, Removal of the DISC TRAY)
- 2) Disconnect the P101, P102, P103 and P104 connectors on the MAIN PCB.
- 3) Remove the four **(A)** screws on the MECHANISM BLOCK.
- 4) Remove the MECHANISM BLOCK from the main chassis.

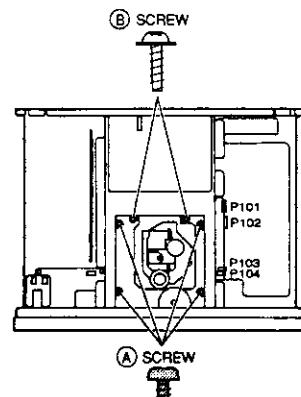


Fig. 3-2

3-3. REPLACEMENT OF TRAVERSE MECHA

- 1) Remove the two **(B)** screws on the MECHANISM BLOCK. (Refer to Fig. 3-2)
- 2) Remove the four **(A)** screws on the TRAVERSE MECHA as shown in Fig. 3-3.

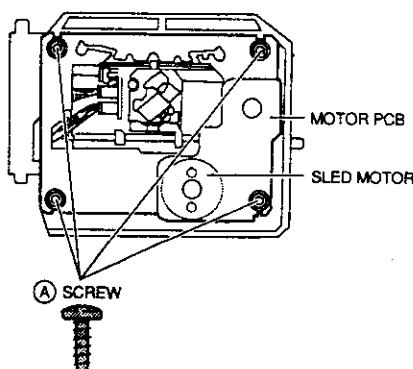


Fig. 3-3

3-4. REPLACEMENT OF THE PICK UP BLOCK

- 1) Release the stoppers of **(A)** gear as shown in Fig. 3-4, then remove it.
- 2) Push the **(A)** stopper in the right direction and pull the SLIDE SHAFT in the forward direction to remove the PICK UP BLOCK, then replace the PICK UP BLOCK.
- 3) Reassemble in the reverse order.

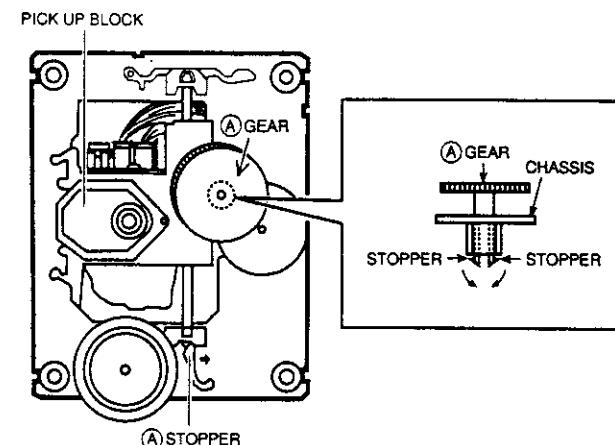


Fig. 3-4

3-5. REPLACEMENT OF THE SPINDLE MOTOR

Replacement of the SPINDLE MOTOR itself is not recommended, because the adjustment of the TURN TABLE height is quite critical and necessitating the use of a special jig.

3-6. REPLACEMENT OF THE SLED MOTOR

- 1) Remove the TRAVERSE MECHA.
- 2) Remove the MOTOR PCB.
- 3) Remove the SLED MOTOR retaining ⑧ screws, then replace the SLED MOTOR.
- 4) Reassemble in the reverse order.

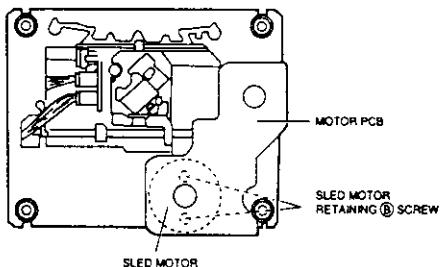


Fig. 3-5

3-7. REPLACEMENT OF THE LOADING MOTOR

- 1) Remove the LOADING BELT and LOADING MOTOR retaining screws.
- 2) Release the Ⓐ and Ⓑ stoppers as shown in Fig. 3-6. Then remove the LOADING MOTOR PCB.
- 3) Reassemble in the reverse order.

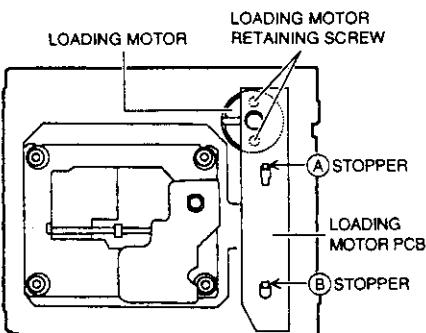
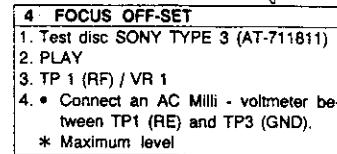
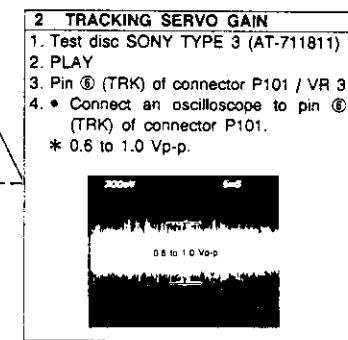
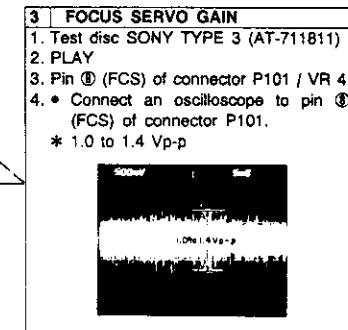
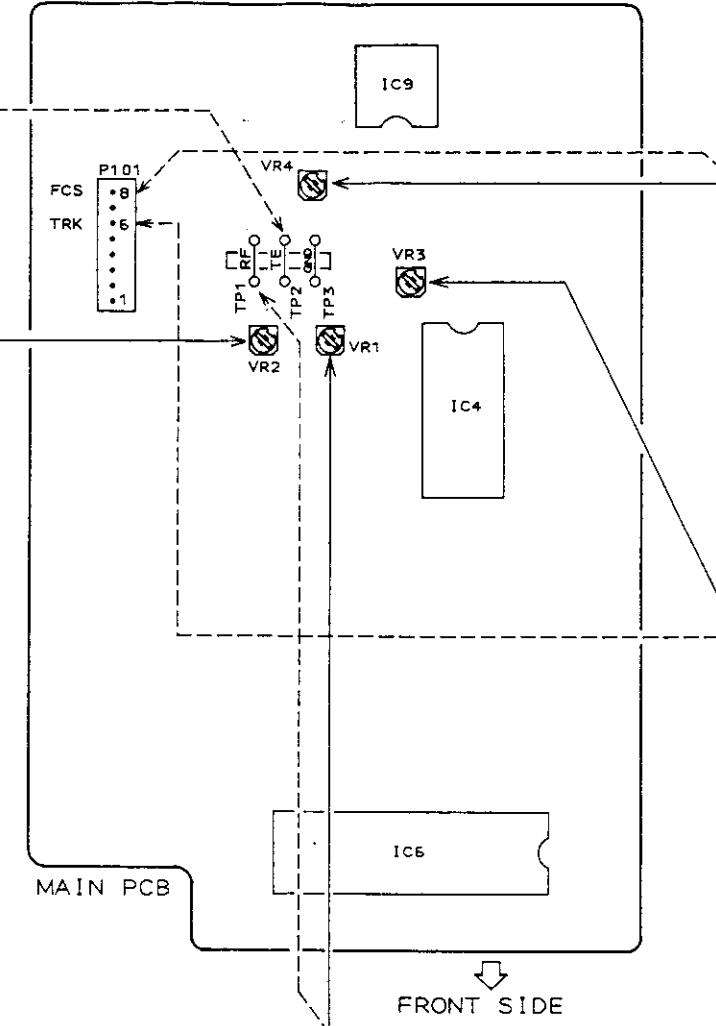
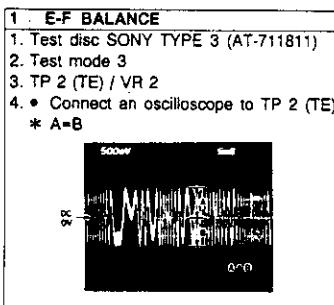
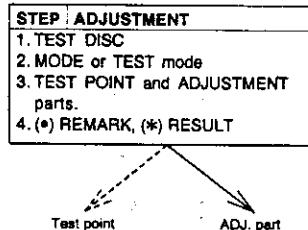


Fig. 3-6

IV. ELECTRICAL ADJUSTMENT

[ABOUT THE TEST MODE]

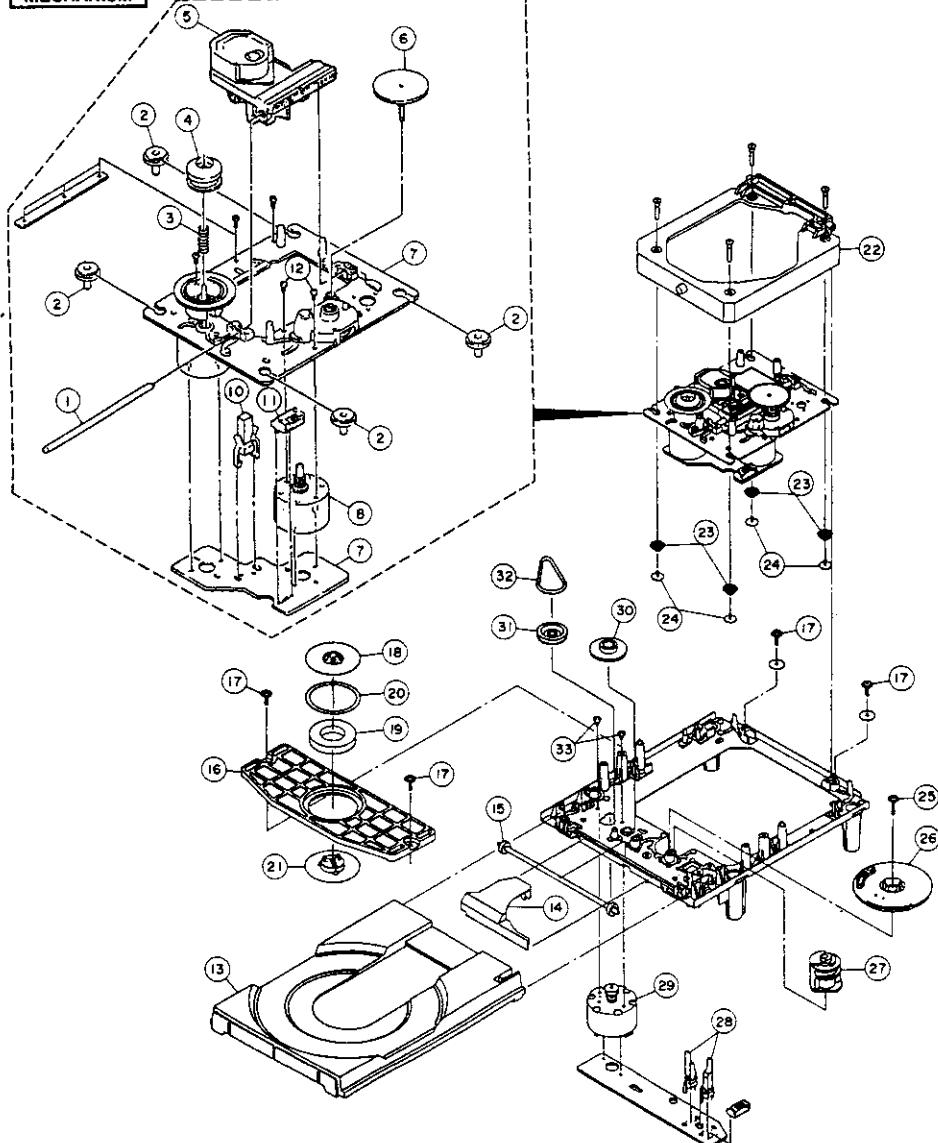
- This TEST mode is used for the adjustment or check.
- How to set into the TEST mode.
Turn the power on, while pressing the DIMMER and \blacktriangleleft buttons on the front panel.
- How to change the TEST mode number.
The TEST mode number will be advanced one by one, each time pressing the \triangleright button and returned to initial number by pressing the \blacktriangleleft button.



*TEST mode condition and DISPLAY

TEST mode	DISPLAY	•
1	00 00 00 00	• Indicates the TEST mode after initialization of the memory for back up.
2	00 00 00 00	• Indicates the end of FOCUS SEARCH.
3	00 00 00 00	• Test mode goes to CLV-S mode and the disc is revolved. If you do not hold the SPINDLE, the disc may go out of control.
4	00 00 00 00	• Indicates that TRACKING SERVO is on.
5	00 00 00 00	• Test mode goes to CLV-A, and SLED SERVO is turned on. In this mode there will be sound, and TRACK NO. and TOTAL TIME will be indicated. The PICK-UP can be moved by using the F.S. Key and B.S.Key.
6	00 00 00 00	• Indicates regular movement.
7	00 00 00 00	• When the OPEN key was pressed to start loading during the 6th stage, the tray will be open during this 7th stage.
8	00 00 00 00	• When the OPEN key was pressed to open the tray during the 7th stage, it will close during this 8th stage .

MECHANISM



NOTE:

Parts will not be supplied if they are not listed in the parts list, even if they appear on the assembling illustrations with reference No.

11. PHONE P.C BOARD

Ref.No.	Part No.	Description
D401	ED-346547	D ZENER H HZ11A1L
	ED-346547	D ZENER H HZ11A1L
FR401	*ER-400605J	R FUSE V T05 ERD2FCV 1/4W15R0G
FR402	*ER-400605J	R FUSE V T05 ERD2FCV 1/4W15R0G
IC401	EI-393323J	IC MS218AL-771
IC402	EI-393323J	IC MS218AL-771
J401	EJ-410554J	PHONE J 3P LGR1212-0102 6.3
TR401	ET-378524J	TR 2SC383 S.T.U
TR402	ET-352726	TR 2SA1392 T.U
VR401	EV-412201J	VR SPL HK16Y12MC A203X2 L=20

12. POWER SW P.C BOARD

Ref.No.	Part No.	Description
C501A	*EC-403337J	C CE V DE7100 F472M 400AC [CD-69]
C501B	*EC-410594J	C MMV V CFKC22E 103M 250AC [CD-79]
SW501	*ES-410570J	SW PJSH SDLD1 BD3.2 01-1

13. DAC SW P.C BOARD

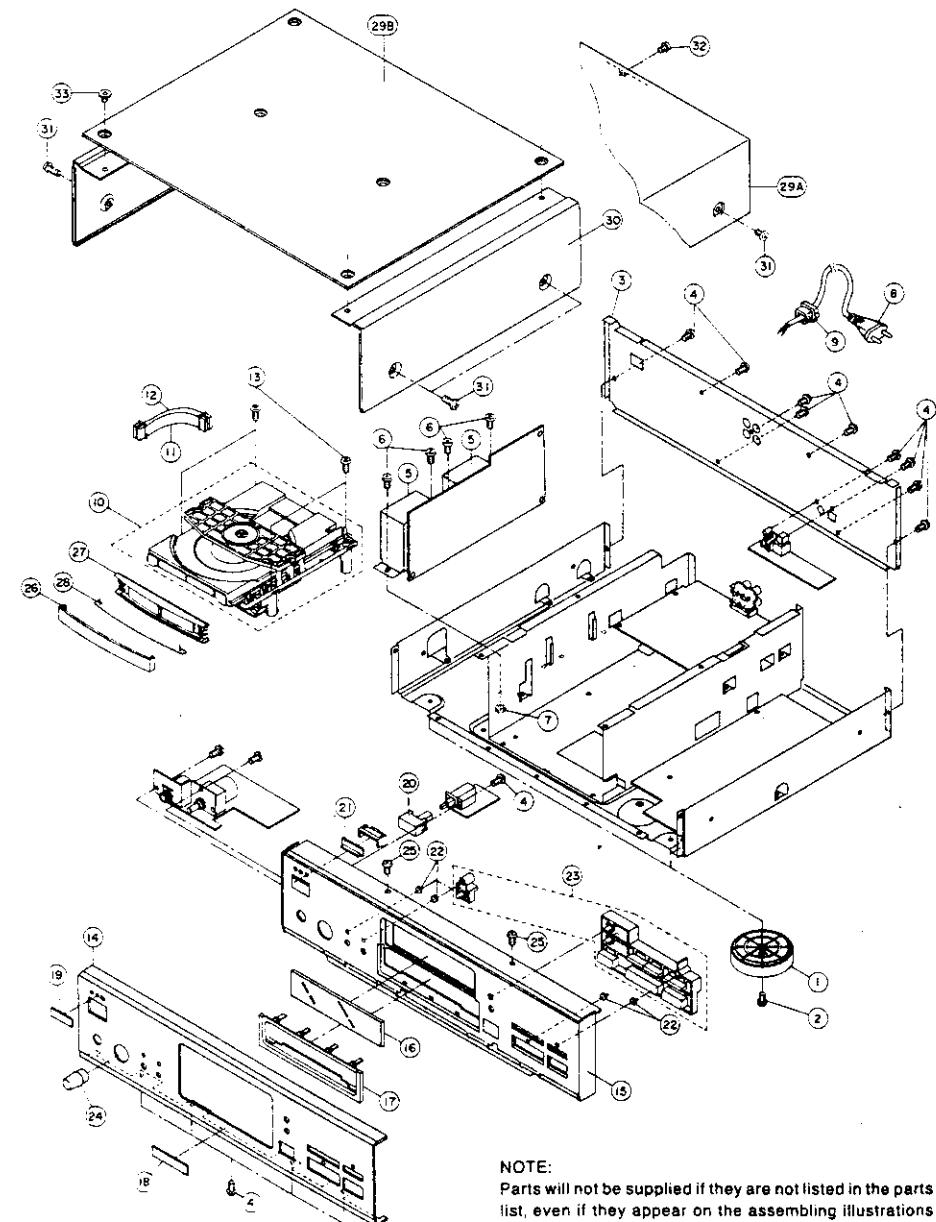
Ref.No.	Part No.	Description
D430	ED-405359J	D LED SEL2915A C.D ORANGE
D431	ED-405359J	D LED SEL2915A C.D ORANGE [CD-79]
SW430	ES-410552J	SW TACT SKHVBE T05
SW431	ES-410552J	SW TACT SKHVBE T05 [CD-79]

14. LED P.C BOARD

Ref.No.	Part No.	Description
D432	ED-409987J	D LED SLR33MC3F GREEN
D433	ED-409987J	D LED SLR33MC3F GREEN

15. FINAL ASSEMBLY

FINAL ASSEMBLY



NOTE:

Parts will not be supplied if they are not listed in the parts list, even if they appear on the assembling illustrations with reference No.

NOTE

ABBREVIATIONS (COMPACT DISC)

ABBREVIATION	EXPLANATION	ABBREVIATION	EXPLANATION
A-D	Analog to Digital (Converter)	Mb	Mega Bits
ADC	Analog to Digital (Converter)	MDA	Motor Drive Amplifier
BCD	Binary Code Decimal	MFM	Modified Frequency Modulation
BPI	Bits per Inch	MM	Mono-stable Multivibrator
CD	Compact Disc	MF MF	Modified Frequency Modulation
CIRC	Cross Interleaving & Reed Solomon Coding	MOD2	Modulo 2 (Addition)
CLV	Constant Linear Velocity	MP	Microprocessor
CP	Clock Pulses	MSB	Most Significant Bit
CRCC	Cyclic Redundancy Check Codes	NA	Numerical Aperture
D Level	Decision Level	NRZ	Non Return to Zero
D-A	Digital to Analog (Converter)	NRZ-1	Non Return to Zero Inverted
DAC	Digital to Analog (Converter)	P	Parity Data
DAD	Digital Audio Disc	PAM	Pulse Amplitude Modulation
DEM	Dynamic Element Matching	PCM	Pulse Code Modulation
DPD	Differential Phase Detection	PD	Phase Detector
DSV	Digital Sum Value	PE	Phase Encode
EFM	Eight to fourteen Modulation	PLL	Phase Locked Loop
EX-OR	Exclusive OR	PNM	Pulse Number Modulation
FCI	Flux Changes per Inch	PPM	Pulse Phase Modulation
FIR	Finite Impulse Response	PWM	Pulse Width Modulation
FP	Front Pulse	Q	Parity Data
FPG	Front Pulse Gate	R, R ₁ , R ₂ , etc.	Data for Right Channel
f	Frequency of Sampling	RAM	Random Access Memory
GF	Galois Field	RPG	Rear Pulse Gate
H & V (Parity)	Horizontal & Vertical	SCOOOP	Self Coupled Optical Pick-up
IIR	Infinite Impulse Response	S & H	Sample & Hold
kb	Kilo Bits	S/N	Signal to Noise Ratio
L, L ₁ , L ₂ , etc.	Data for Left Channel	SSG	Standard Signal Generator
LPF	Low Pass Filter	SYSCON	SYStem CONtrol
LSB	Least Significant Bit		

AKAI

MODEL CD-69

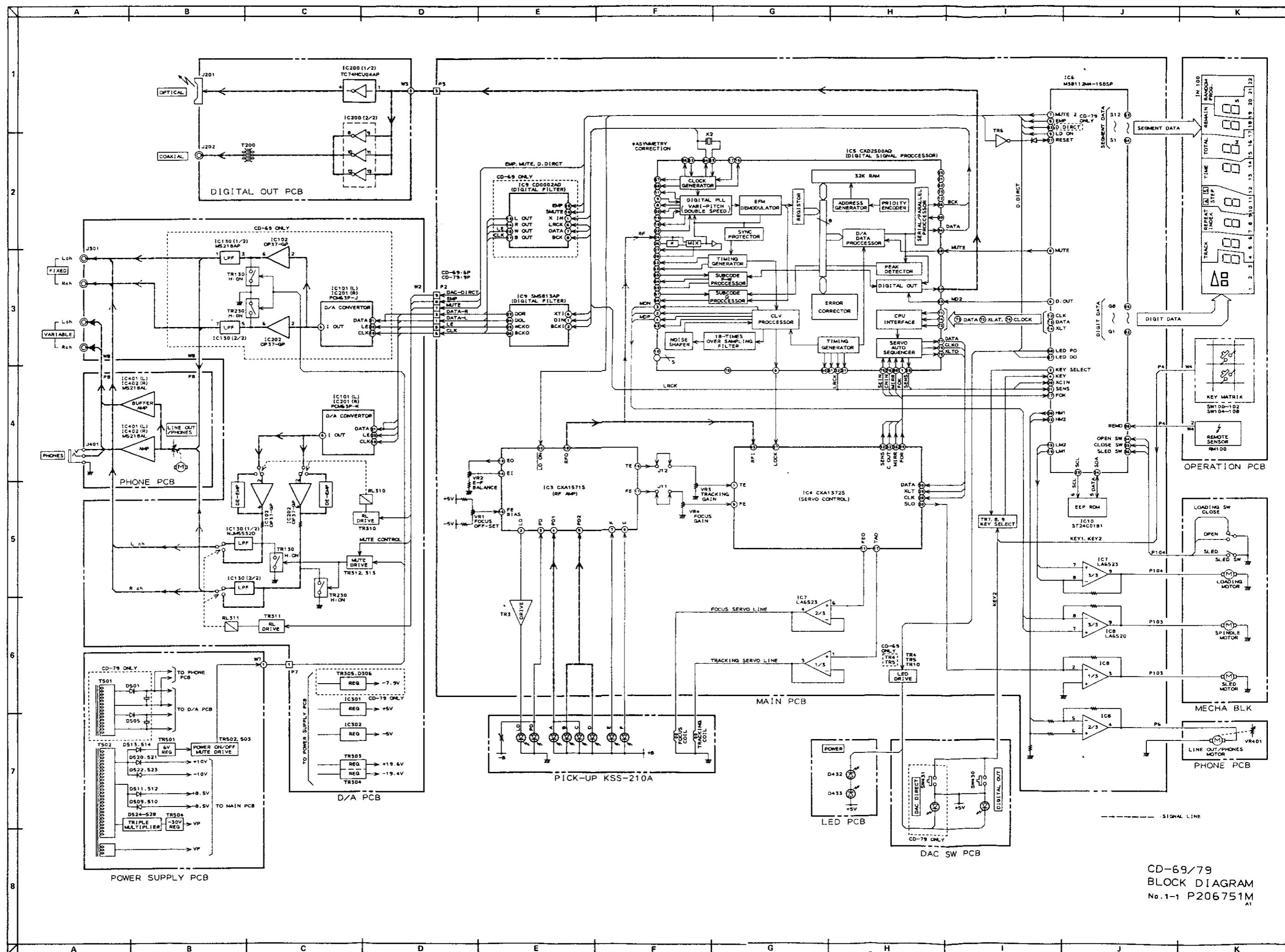
MODEL CD-79

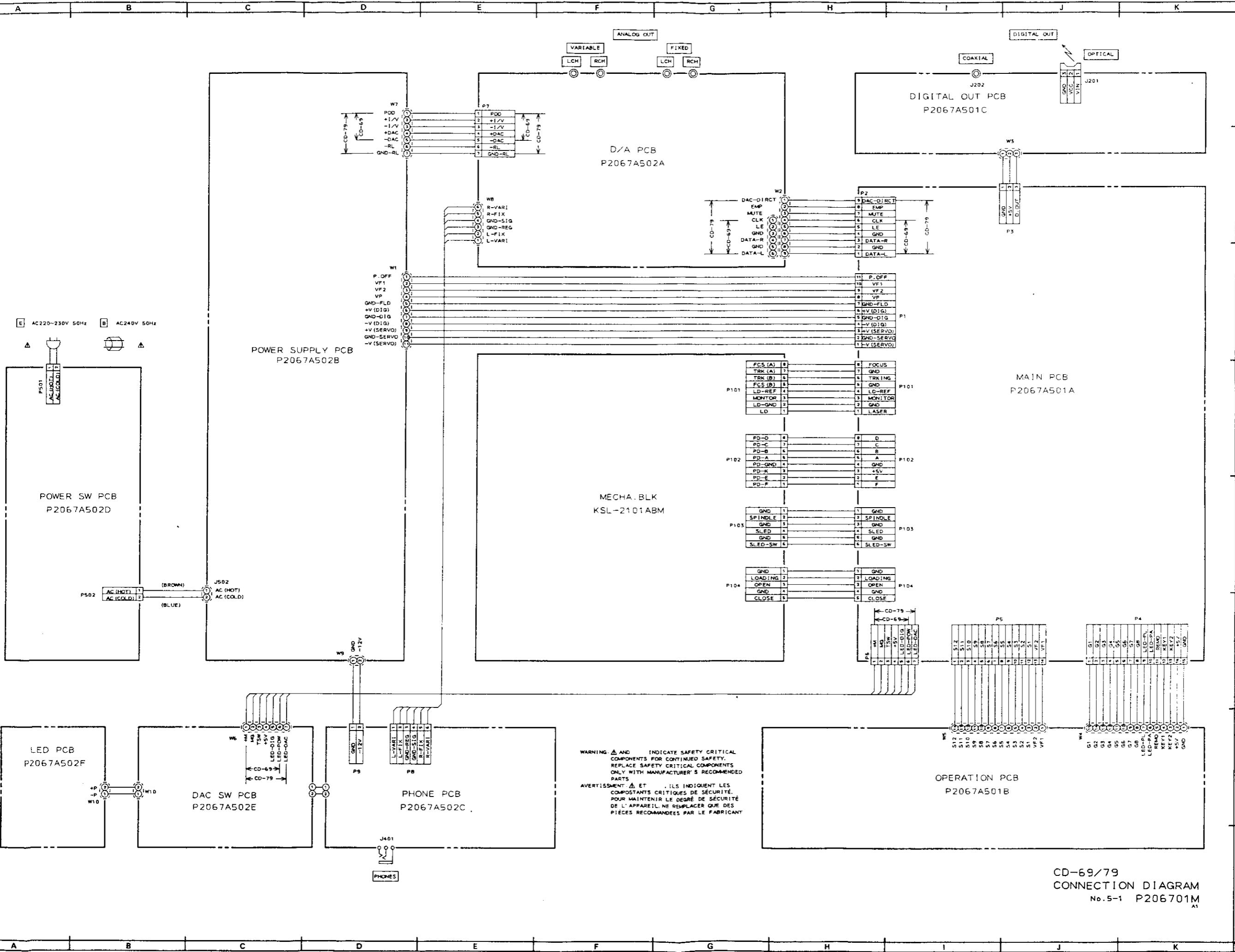
SCHEMATIC DIAGRAMS AND PC BOARDS

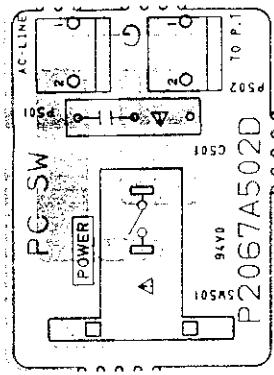
TABLE OF CONTENTS

1. BLOCK DIAGRAM	3
2. CD-69, 79 CONNECTION DIAGRAM	4
3. POWER SW AND POWER SUPPLY PC BOARDS	5
4. D/A AND OTHER PC BOARDS	6
5. CD-69 POWER SUPPLY & D/A SCHEMATIC DIAGRAM	7
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10. CD-79 MAIN & OPERATION SCHEMATIC DIAGRAM	12
11. DIGITAL OUT AND OPERATION PC BOARDS	14
12. INFORMATION OF ICs	15

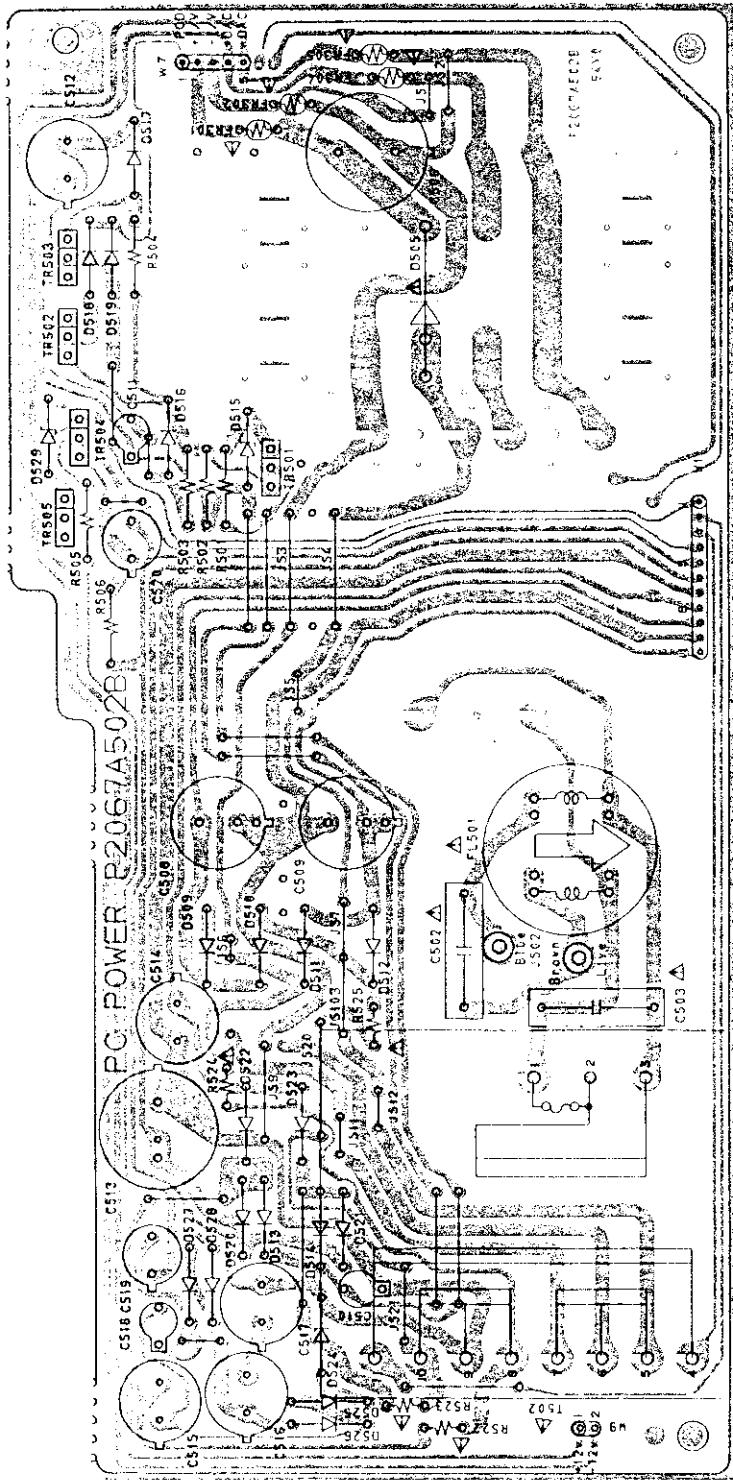
Use these schematic diagrams and PC boards together with the provided service manual.







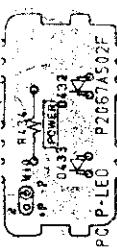
POWER SW PCB P2067A502D



POWER SUPPLY PCB P2067A502B

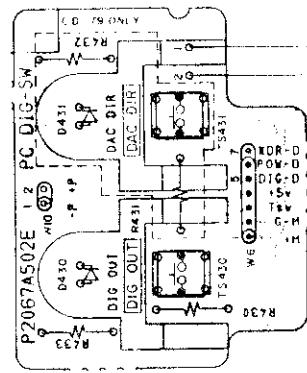
WARNING △ INDICATES SAFETY CRITICAL COMPONENTS FOR CONTINUED SAFETY
REPLACE SAFETY CRITICAL COMPONENTS ONLY WITH MANUFACTURER'S
RECOMMENDED PARTS

Avertissement : △ indique les composants de sécurité de l'appareil.
POUR MAINTENIR LE DEGRÉ DE SÉCURITÉ, NE PAS remplacer que des pièces recommandées par le fabricant.

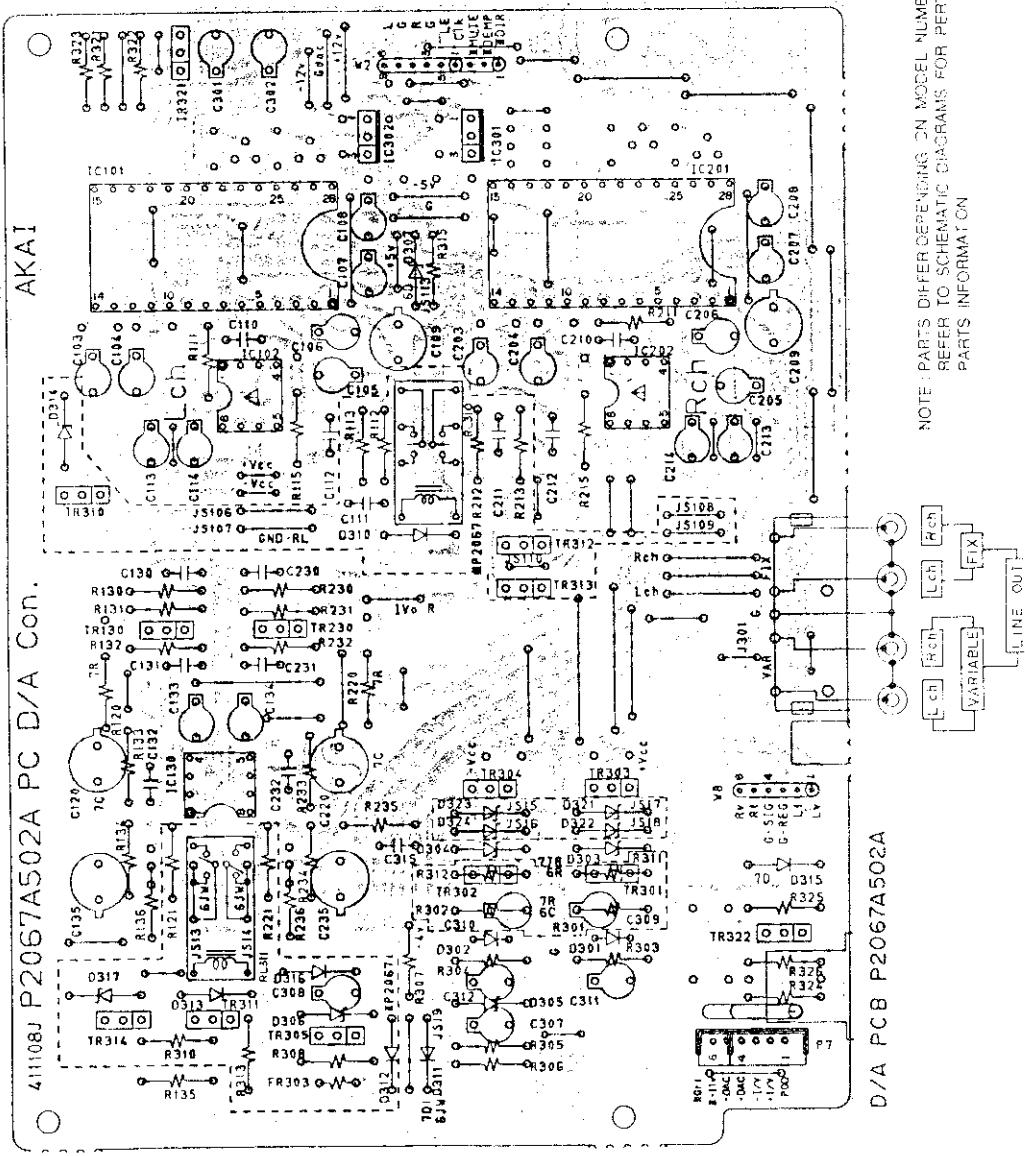


LED PCB
P2067A502F

DAC SW PCB P2067A502E



41108 P2067A502A PC D/A Con.

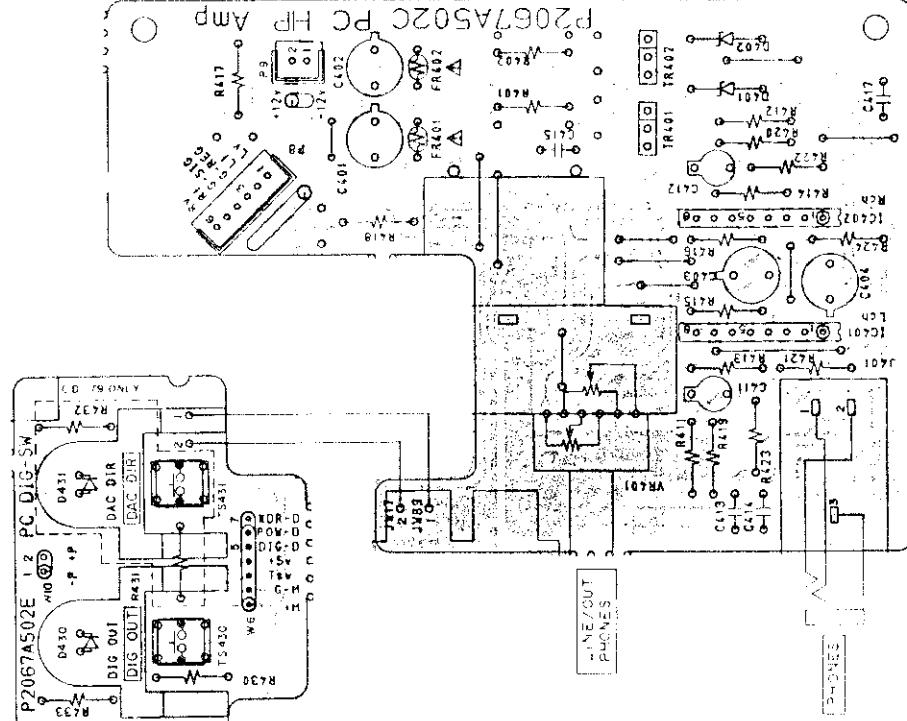


D/A PCB P2067A502A

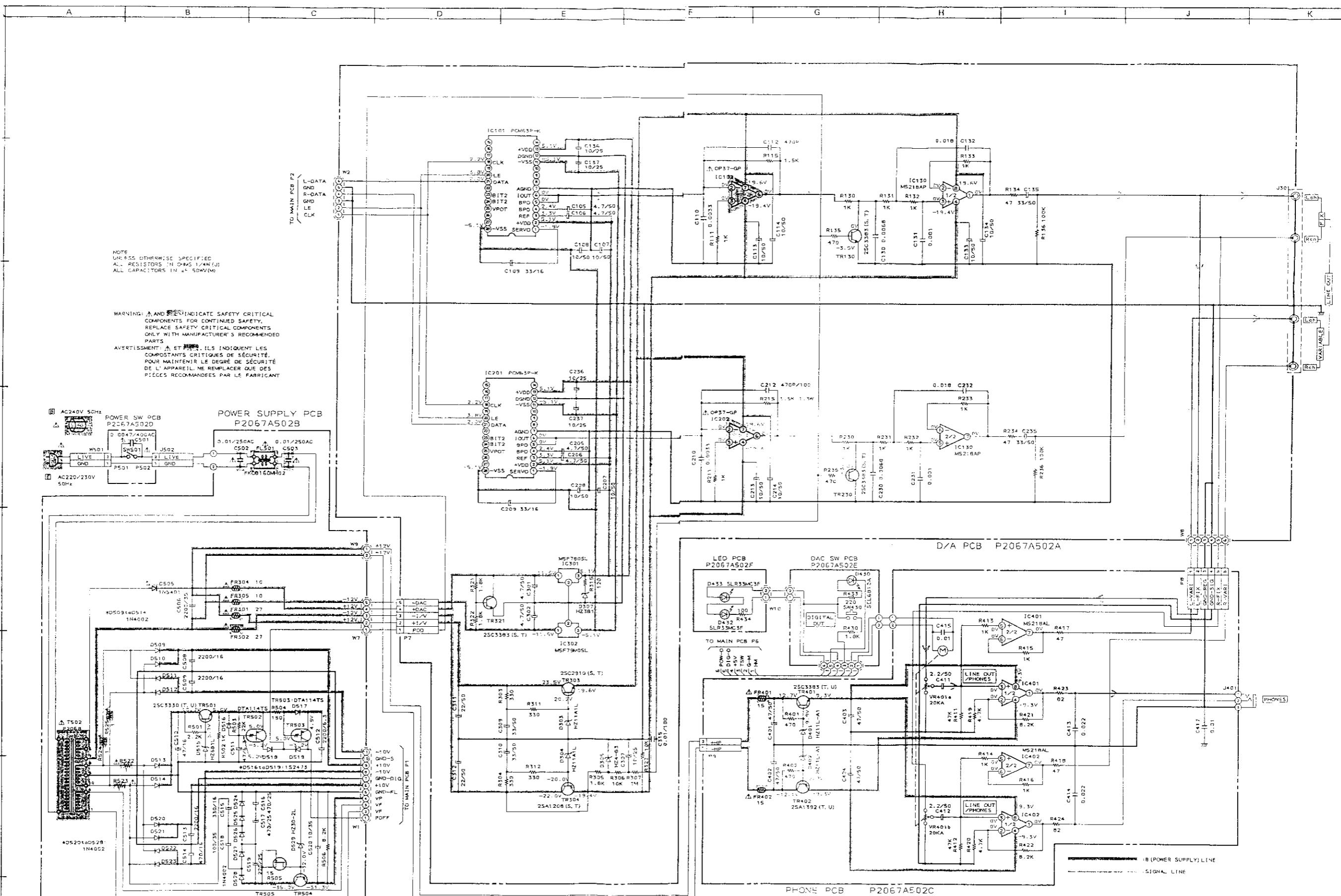
NOTE PARTS DIFFERENTIATING 2N MODEL NUMBER
REFER TO SCHEMATIC DIAGRAMS FOR PERTINENT
PARTS INFORMATION

WIRING: \$ INDICATES SIMILAR ELECTRICAL COMPONENTS FOR COMMON FUNCTIONS
REPAIR SAFETY: PRINTED CIRCUIT BOARD, WIRE, AND VARIOUS PLATELAYER
ATTACHMENT: UNDRILLED HOLE, COMPOUND ANGLED, VERTICAL, REVERSE
P2067A502A VARIATION: USE OF FEEDBACK, GAIN, AND PHASE COMPENSATION
PCB: PRINTED CIRCUIT BOARD, PRINTED CIRCUIT BOARD, PRINTED CIRCUIT BOARD

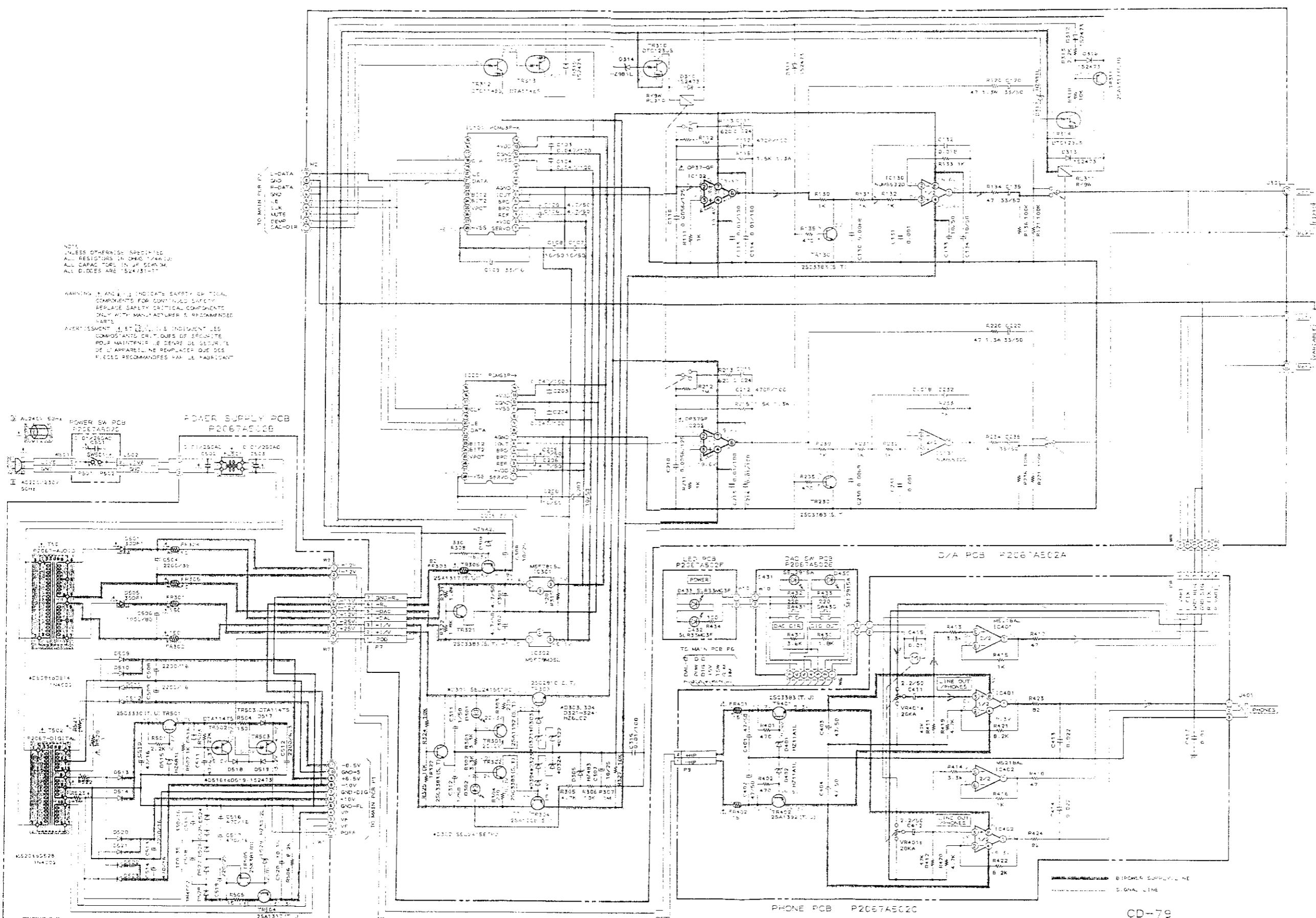
PHONE PCB P2067A502C



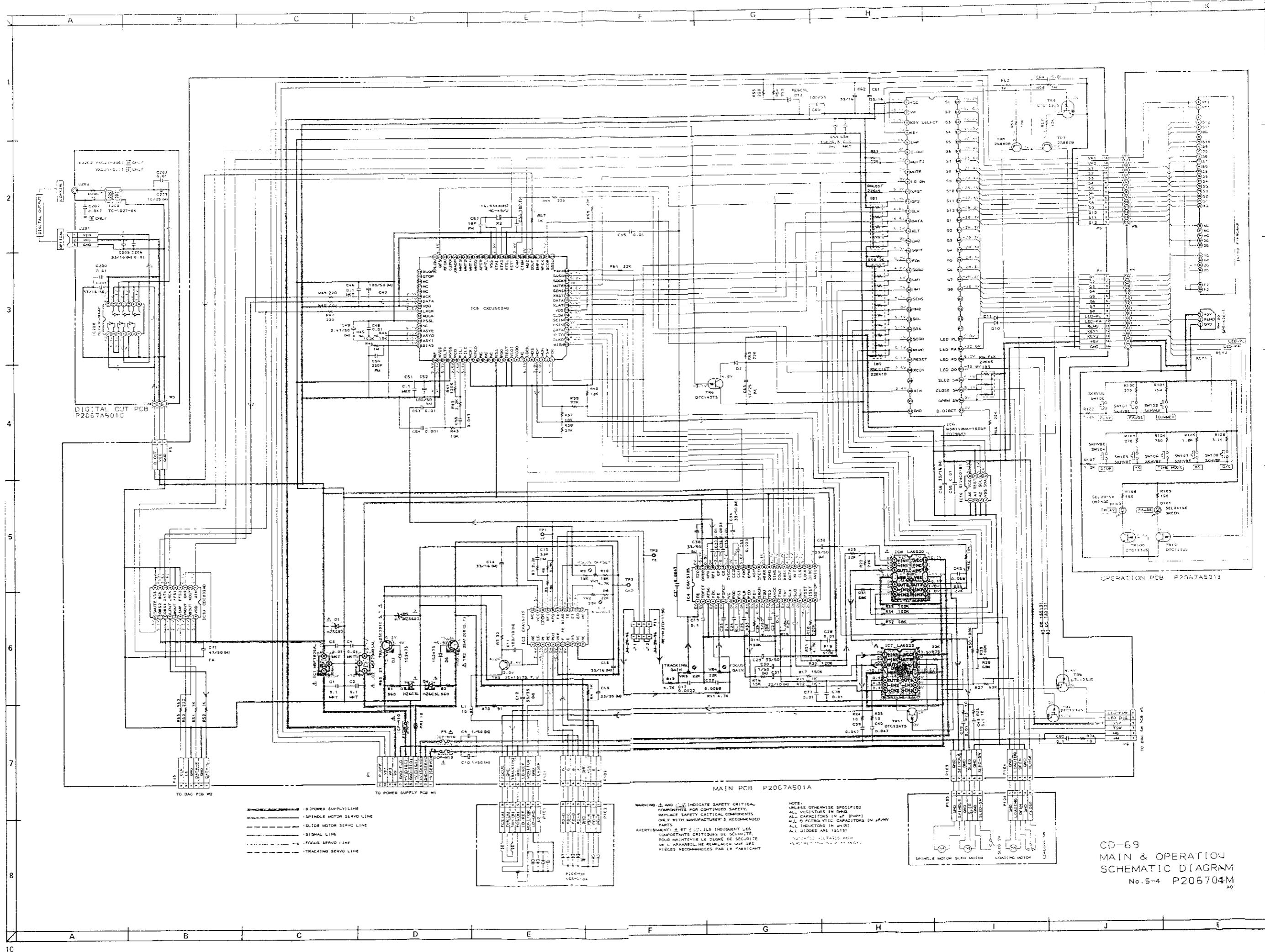
WIRING: \$ INDICATES SIMILAR ELECTRICAL COMPONENTS FOR COMMON FUNCTIONS
REPAIR SAFETY: PRINTED CIRCUIT BOARD, WIRE, AND VARIOUS PLATELAYER
ATTACHMENT: UNDRILLED HOLE, COMPOUND ANGLED, VERTICAL, REVERSE
P2067A502C VARIATION: USE OF FEEDBACK, GAIN, AND PHASE COMPENSATION
PCB: PRINTED CIRCUIT BOARD, PRINTED CIRCUIT BOARD, PRINTED CIRCUIT BOARD

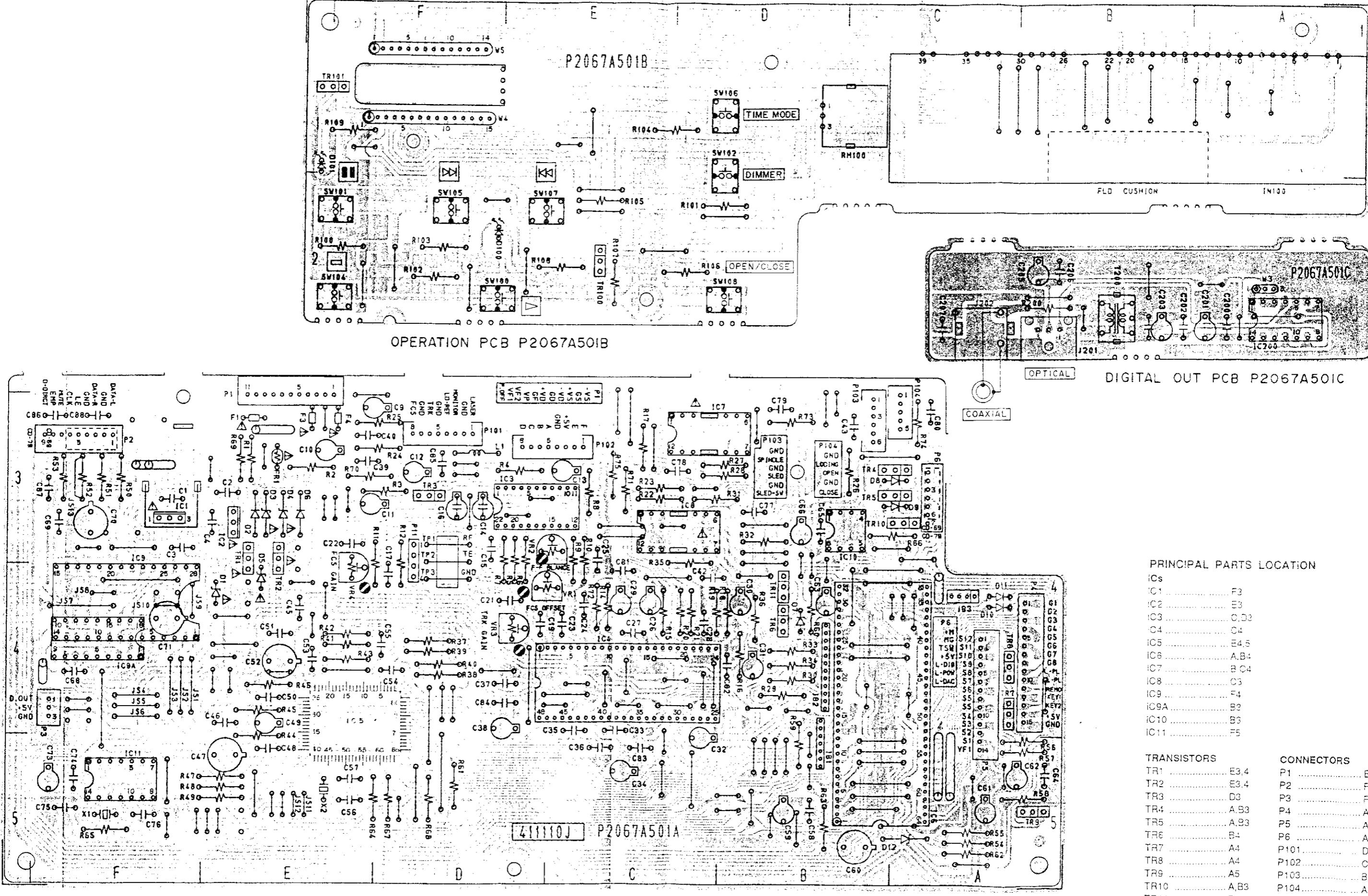


CD-69
POWER SUPPLY & D/A
SCHEMATIC DIAGRAM
No.5-2 P206702M



CD-79
POWER SUPPLY & D/A
SCHEMATIC DIAGRAM
No 5-3 P206703M

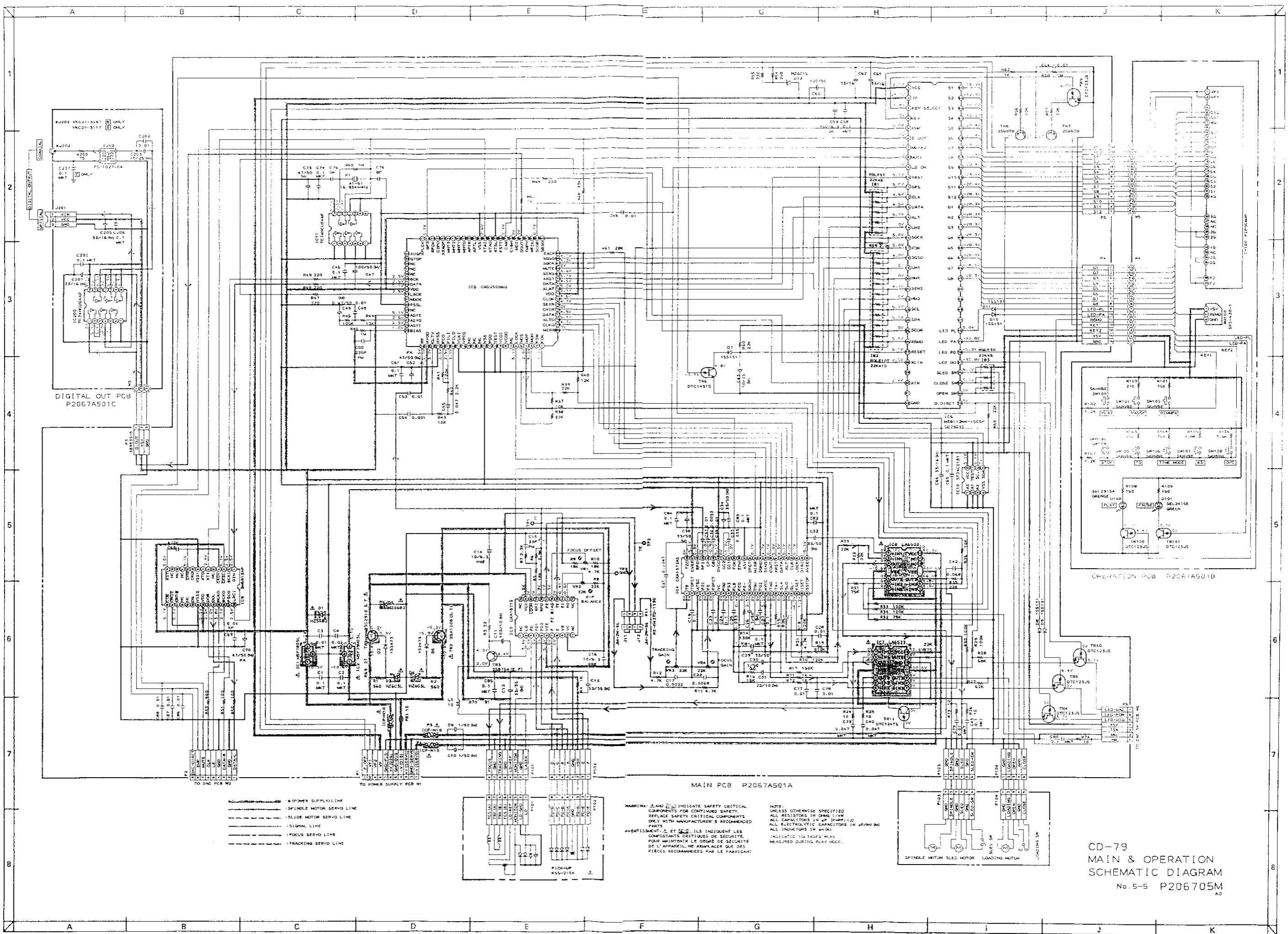




WARNING INDICATES SAFETY CRITICAL COMPONENTS FOR CONTINUED SAFETY.
REPLACE SAFETY CRITICAL COMPONENTS ONLY WITH MANUFACTURER'S
RECOMMENDED PARTS.

AVERTISSEMENT. INDIQUE LES COMPOSANTS CRITIQUES DE SÉCURITÉ.
POUR MAINTENIR LE DEGRÉ DE SÉCURITÉ DE L'APPAREIL,
NE REMPLACER QUE DES PIÈCES RECOMMANDÉES PAR LE FABRICANT.

NOTE : PARTS DIFFER DEPENDING ON MODEL NUMBER.
REFER TO SCHEMATIC DIAGRAMS FOR PERTINENT
PARTS INFORMATION.



PRINCIPAL PARTS LOCATION

ICs

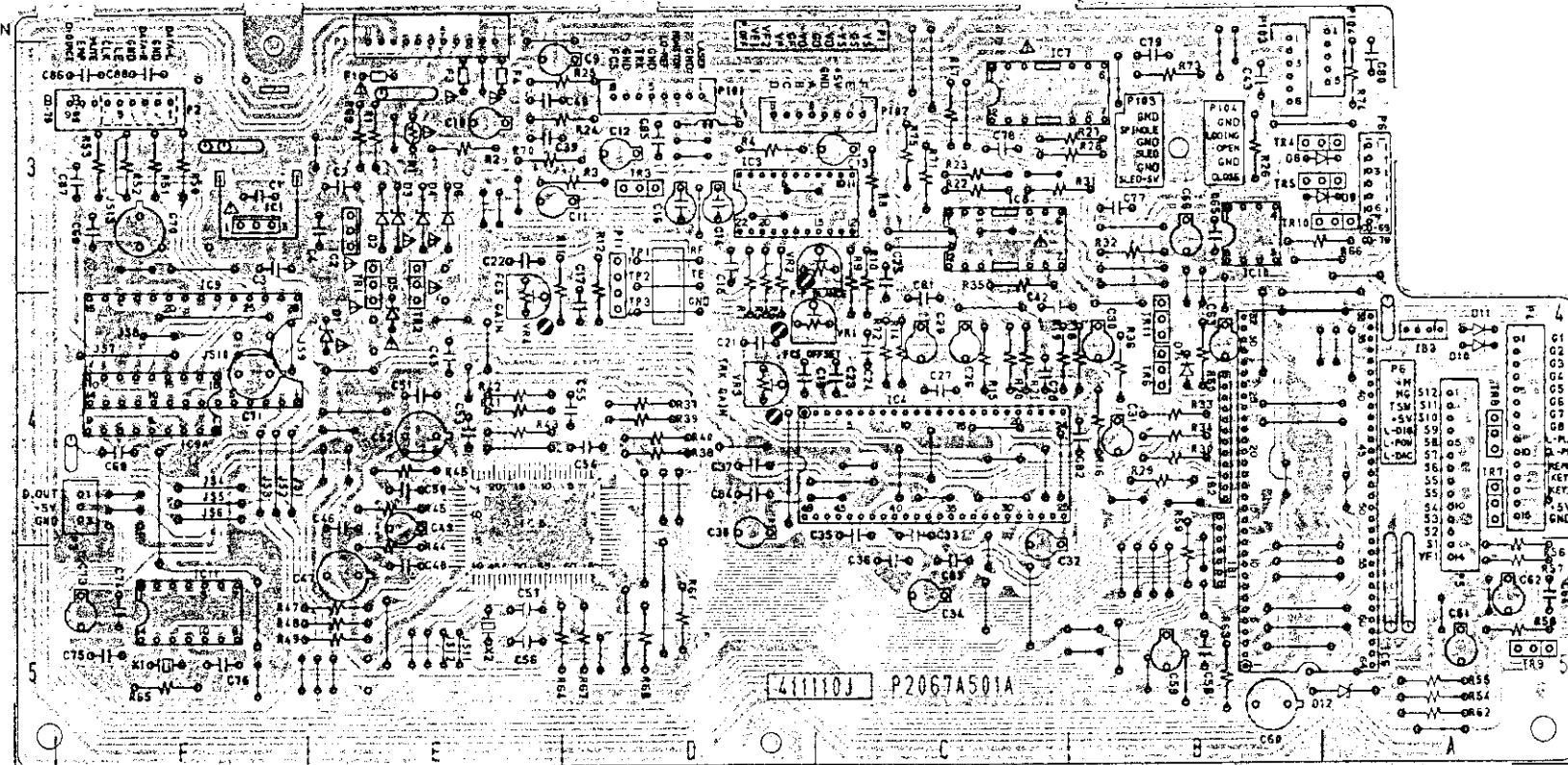
C1 F3
 C2 E3
 C3 C,D3
 C4 C4
 IC5 E4,5
 IC6 A,B4
 IC7 B,C4
 IC8 C3
 IC9 F4
 IC9A B3
 IC10 B3
 IC11 F5

TRANSISTORS

TR1 E3,4
 TR2 E3,4
 TR3 D3
 TR4 A,B3
 TR5 A,B3
 TR6 B4
 TR7 A4
 TR8 A4
 TR9 A5
 TR10 A,B2
 TR11 B4

CONNECTORS

P1 E3
 P2 F3
 P3 F4
 P4 A4
 P5 A4
 P6 A3
 P101 D3
 P102 C,D3
 P103 B3
 P104 A3

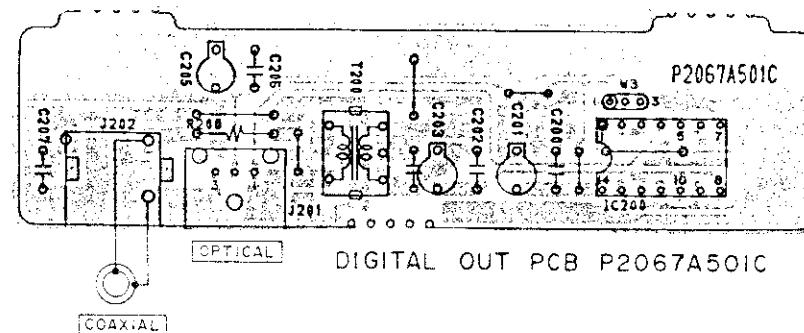


WARNING: INDICATES SAFETY CRITICAL COMPONENTS. FOR CONTINUED SAFETY
 REPLACE SAFETY CRITICAL COMPONENTS ONLY WITH MANUFACTURER'S
 RECOMMENDED PARTS.

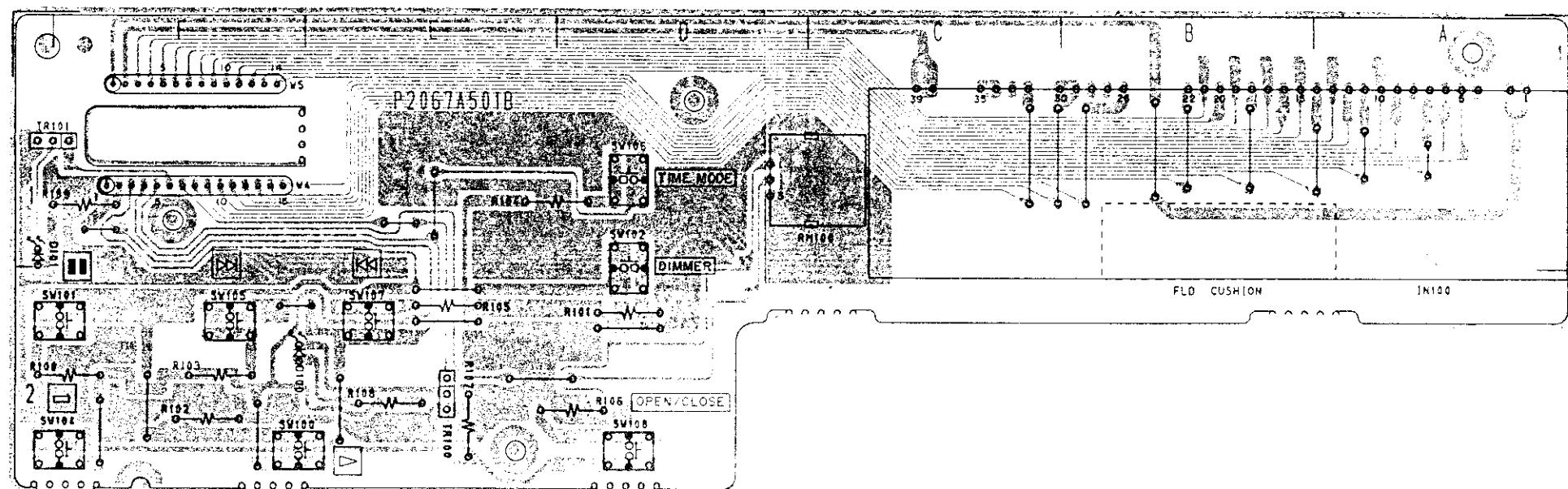
Avertissement: AIL INDIQUE LES COMPOSANTS CRITIQUES DE SECURITE.
 POUR MAINTENIR LE DEGRE DE SECURITE DE L'APPAREIL,
 NE REMPLACER QUE DES PIECES RECOMMANDÉES PAR LE FABRICANT.

MAIN PCB P2067A501A

NOTE: PARTS DIFFER DEPENDING ON MODEL NUMBER.
 REFER TO SCHEMATIC DIAGRAMS FOR PERTINENT
 PARTS INFORMATION.



DIGITAL OUT PCB P2067A501C



OPERATION PCB P2067A501B

SM5813AP (DIGITAL FILTER)

Pin No.	Symbol	I/O	Description												
1	DIN	I	Data input												
2	BCKI	I	Bit clock for input data												
3	CKSL	I	Master clock XTI select *												
4	CKDV	I	Master clock XTI select *												
5	N.C	-	No connection												
6	XTI	I	Crystal OSC input *												
7	XTO	O	Crystal OSC output												
8	VSS1	-	GND												
9	CKO	O	Clock out *												
10	SYN	I	Jitter free mode or forced synchronization mode select H = Jitter free, L = Forced synchronization												
11	N.C	-	No connection												
12	N.C	-	No connection												
13	N.C	-	No connection												
14	RST	I	System reset H = normal, L = System reset												
15	COB	I	Selection of replenishing number 2 or COB H = Replenishing number 2, L = COB												
16	OW20	I	Bit select												
17	OW18	I	<table border="1" style="margin-left: auto; margin-right: auto;"> <tr> <td>BIT</td> <td>16</td> <td>18</td> <td>20</td> </tr> <tr> <td>OW18</td> <td>H</td> <td>L</td> <td>H</td> </tr> <tr> <td>OW20</td> <td>H</td> <td>H</td> <td>L</td> </tr> </table>	BIT	16	18	20	OW18	H	L	H	OW20	H	H	L
BIT	16	18	20												
OW18	H	L	H												
OW20	H	H	L												
18	N.C	-	No connection												
19	N.C	-	No connection												
20	DG	O	Deglitch control clock												
21	VSS2	-	GND												
22	VDD	-	+5 V												
23	DOR	O	Over sampling for output data (Rch)												
24	DOL	O	Over sampling for output data (Lch)												
25	WCKO	O	Word clock for output data												
26	BCKO	O	Bit clock for output data												
27	FSCO	O	fs timing clock												
28	LRCI	I	Sample rate (fs) clock for input data H = Lch, L = R ch												

* Master clock frequency can be selected by CKSL, CKDV and CKO condition as shown below.

192 fs: CKSL = H, CKDV = H
384 fs: CKSL = H, CKDV = L
256 fs: CKSL = L, CKDV = L
512 fs: CKSL = L, CKDV = L